



### 10A DUAL LOW VF SCHOTTKY BARRIER RECTIFIER POWERDI®5

### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F max</sub> (V)	I <sub>R max</sub> (mA) @ 40V
40	10	0.50	0.2

### **Features and Benefits**

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- Very Low Reverse Leakage Current
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Description and Applications**

PDS1040CTL is a dual die Schottky barrier rectifier in POWERDI<sup>®</sup>5 package. It is designed for use in low voltage, high frequency inverters, ORing, and polarity protection applications.

## **Mechanical Data**

- Case: POWERDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
   Solderable per MIL-STD-202, Method 208<sup>®</sup>
- Polarity: See Diagram
- Weight: 0.096 grams (Approximate)

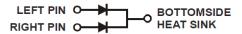
### POWERDI<sup>®</sup>5







**Bottom View** 



### Ordering Information (Note 4)

t-		
Part Number	Case	Packaging
PDS1040CTL-13	POWERDI <sup>®</sup> 5	5.000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

### POWERDI<sup>®</sup>5



S1040CTL = Product Type Marking Code

OH:= Manufacturer's Code Marking

YYWW = Date Code Marking

YY = Last Digit of Year (ex: 15 for 2015)

WW = Week Code (01 - 53)

K = Factory Designator Code



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current	per element total device	Io	5 10	А
Non-Repetitive Peak Forward Surge Current, per element 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I <sub>FSM</sub>	110	А

## **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	_	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	95	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	75	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	50	_	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to	+150	°C

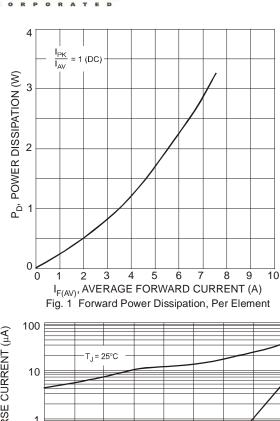
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

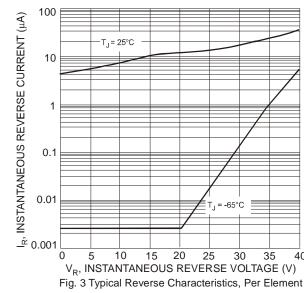
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)		40	_	_	V	I <sub>R</sub> = 500μA
			0.465	0.50	V	I <sub>F</sub> = 5A, T <sub>S</sub> = +25°C
	VF	_	0.41	0.45		I <sub>F</sub> = 5A, T <sub>S</sub> = +100°C
Forward Valtage Day Florent		_	0.39	0.43		I <sub>F</sub> = 5A, T <sub>S</sub> = +125°C
Forward Voltage Per Element		_	0.55	0.60		I <sub>F</sub> = 10A, T <sub>S</sub> = +25°C
		_	0.53	0.57		I <sub>F</sub> = 10A, T <sub>S</sub> = +100°C
		_	0.52	0.56		I <sub>F</sub> = 10A, T <sub>S</sub> = +125°C
	I <sub>R</sub>		20	200	μA	$V_R = 40V, T_S = +25^{\circ}C$
		_	3	25	mA	$V_R = 40V, T_S = +100$ °C
Poverse Leakage Current (Note 9) Per Floment		_	15	150	μA	$V_R = 35V, T_S = +25^{\circ}C$
Reverse Leakage Current (Note 8) Per Element		_	2.5	10	mA	$V_R = 35V, T_S = +100$ °C
		_	6	80	μΑ	V <sub>R</sub> = 17.5V, T <sub>S</sub> = +25°C
		_	1	5	mA	V <sub>R</sub> = 17.5V, T <sub>S</sub> = +100°C

Notes:

- 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 6. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
- 8. Short duration pulse test used to minimize self-heating effect.







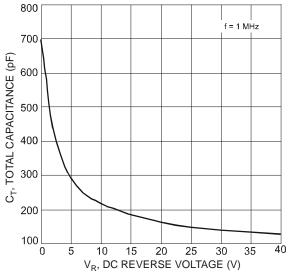
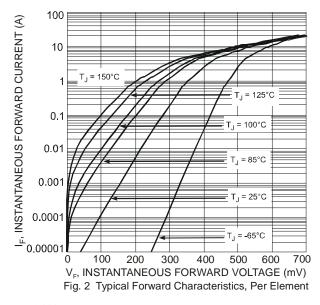
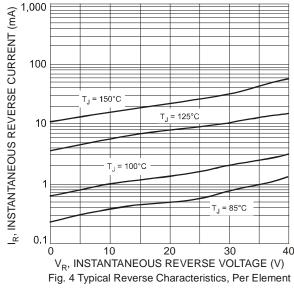


Fig. 5 Total Capacitance vs. Reverse Voltage, Per Element





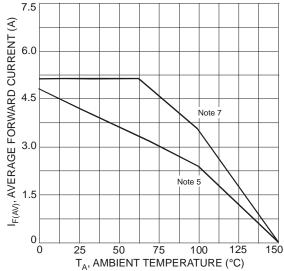
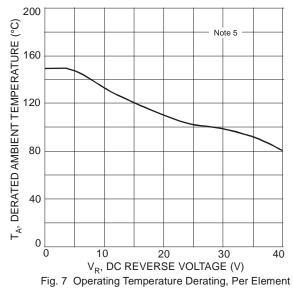


Fig. 6 Forward Current Derating Curve, Per Element

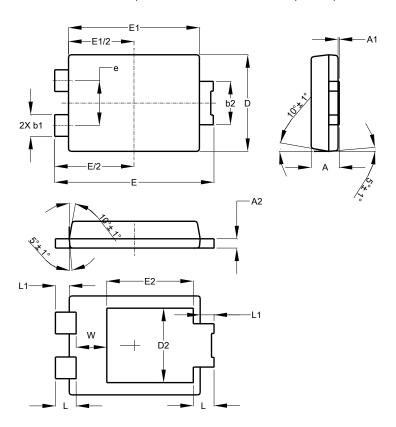






## **Package Outline Dimensions**

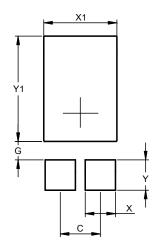
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI <sup>®</sup> 5					
Dim	Min Max Ty		Тур		
Α	1.05	1.15	1.10		
A1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2			3.054		
Е	6.40	6.60	6.504		
е	1.84		1.84		
E1	5.30	5.45	5.37		
E2	<b>E2</b> 3.549				
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	1.840		
O	0.852		
Х	1.390		
X1	3.360		
Υ	1.400		
V1	4.860		



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